# May 2008

rev 0.1



# PCS3P625Z05B/C PCS3P625Z09B/C

# High Frequency Timing-Safe™ Peak EMI reduction IC

### **General Features**

- High Frequency Clock distribution with Timing-٠ Safe<sup>™</sup> Peak EMI Reduction
- Input frequency range: 100MHz 175MHz
- Multiple low skew Timing-safe<sup>™</sup> Outputs: PCS3P625Z05: 5 Outputs PCS3P625Z09: 9 Outputs
- External Input-Output Delay Control option •
- Supply Voltage: 3.3V±0.3V
- Commercial and Industrial temperature range
- Packaging Information: ASM3P625Z05: 8 pin SOIC, and TSSOP ASM3P625Z09:16 pin SOIC, and TSSOP
- True Drop-in Solution for Zero Delay Buffer, ASM5P2305A / 09A

### **Functional Description**

**General Block Diagram** 

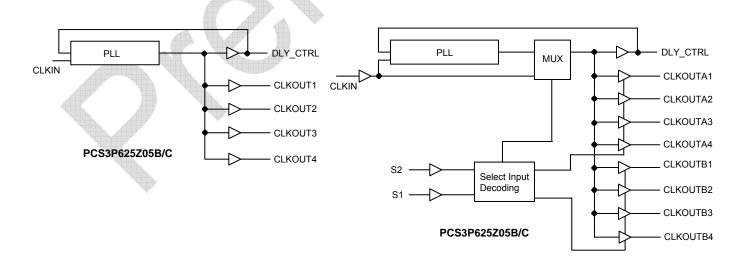
PCS3P625Z05/09 is a versatile, 3.3V Zero-delay buffer designed to distribute high frequency Timing-Safe™ clocks with Peak EMI reduction. PCS3P625Z05 is an eight-pin version, accepts one reference input and drives out five low-skew Timing-Safe™ clocks. PCS3P625Z09 accepts one reference input and drives out nine low-skew Timing-Safe™clocks.

PCS3P625Z05/09 has a DLY\_CTRL for adjusting the Input-Output clock delay, depending upon the value of capacitor connected at this pin to GND.

PCS3P625Z05/09 operates from a 3.3V supply and is available in two different packages, as shown in the ordering information table, over commercial and Industrial temperature range.

### Application

PCS3P625Z05/09 is targeted for use in Displays and memory interface systems.



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#### **Spread Spectrum Frequency Generation**

The clocks in digital systems are typically square waves with a 50% duty cycle and as frequencies increase the edge rates also get faster. Analysis shows that a square wave is composed of fundamental frequency and harmonics. The fundamental frequency and harmonics generate the energy peaks that become the source of EMI. Regulatory agencies test electronic equipment by measuring the amount of peak energy radiated from the equipment. In fact, the peak level allowed decreases as the frequency increases. The standard methods of reducing EMI are to use shielding, filtering, multi-layer PCBs etc. These methods are expensive. Spread spectrum clocking reduces the peak energy by reducing the Q factor of the clock. This is done by slowly modulating the clock frequency. The PCS3P625Z05/09 uses the center modulation spread spectrum technique in which the modulated output frequency varies above and below the reference frequency with a specified modulation rate. With center modulation, the average frequency is the same as the unmodulated frequency and there is no performance degradation

#### Zero Delay and Skew Control

All outputs should be uniformly loaded to achieve Zero Delay between input and output. Since the DLY\_CTRL pin is the internal feedback to the PLL, its relative loading can adjust the input-output delay. For applications requiring zero input-output delay, all outputs, including DLY\_CTRL, must be equally loaded. Even if DLY\_CTRL is not used, it must have a capacitive load equal to that on other outputs, for obtaining zero-input-output delay.

#### Timing-Safe<sup>™</sup> technology

Timing-Safe<sup>™</sup> technology is the ability to modulate a clock source with Spread Spectrum technology and maintain synchronization with any associated data path.

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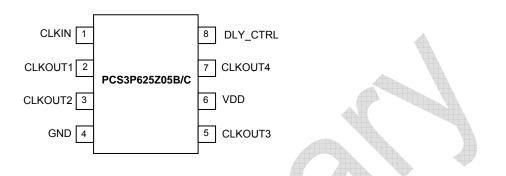


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### Pin Configuration for PCS3P625Z05B/C

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### Pin Description for PCS3P625Z05B/C

Pin #	Pin Name	Туре	Description
1	CLKIN <sup>1</sup>	Ι	External reference Clock input, 5V tolerant input
2	CLKOUT1 <sup>2</sup>	0	Buffered clock output <sup>4</sup>
3	CLKOUT2 <sup>2</sup>	0	Buffered clock output <sup>4</sup>
4	GND	Р	Ground
5	CLKOUT3 <sup>2</sup>	0	Buffered clock output <sup>4</sup>
6	VDD	P	3.3V supply
7	CLKOUT4 <sup>2</sup>	0	Buffered clock output <sup>4</sup>
8	DLY_CTRL	0	External Input-Output Delay control. This pin can be used as clock output <sup>4</sup>

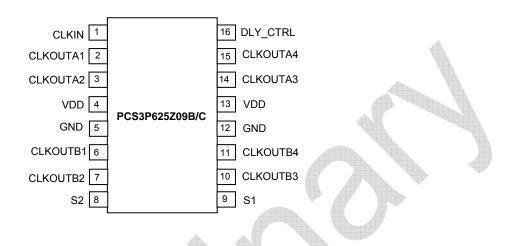




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### Pin Configuration for PCS3P625Z09B/C



#### Pin Description for PCS3P625Z09B/C

Pin #	Pin Name	Pin Type	Description
1		Ι	External reference Clock input, 5V tolerant input
2	CLKOUTA1 <sup>2</sup>	0	Buffered clock Bank A output <sup>4</sup>
3	CLKOUTA2 <sup>2</sup>	0	Buffered clock Bank A output <sup>4</sup>
4	VDD	Р	3.3V supply
5	GND	Р	Ground
6	CLKOUTB1 <sup>2</sup>	0	Buffered clock Bank B output <sup>4</sup>
7	CLKOUTB2 <sup>2</sup>	0	Buffered clock Bank B output <sup>4</sup>
8	S2 <sup>3</sup>		Select input, bit 2.See Select Input Decoding table for PCS3P625Z09 for more details
9	S1 <sup>3</sup>		Select input, bit 1.See Select Input Decoding table for PCS3P625Z09 for more details
10	CLKOUTB3 <sup>2</sup>	0	Buffered clock Bank B output <sup>4</sup>
11	CLKOUTB4 <sup>2</sup>	0	Buffered clock Bank B output <sup>4</sup>
12	GND	Р	Ground
13	VDD	Р	3.3V supply
14	CLKOUTA3 <sup>2</sup>	0	Buffered clock Bank A output <sup>4</sup>
15	CLKOUTA4 <sup>2</sup>	0	Buffered clock Bank A output <sup>4</sup>
16	DLY_CTRL <sup>2</sup>	0	External Input-Output Delay control. This pin can be used as clock output

Notes: 1. Weak pull down

2. Weak pull-down on all outputs

Weak pull-up on these Inputs
Buffered clock output is Timing-Safe™

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#### Select Input Decoding table for PCS3P625Z09

S2	S1	CLKOUT A1 - A4	CLKOUT B1 - B4	DLY_CTRL <sup>1</sup>	Output Source	PLL Shut-Down
0	0	Three-state	Three-state	Driven	PLL	Ν
0	1	Driven	Three-state	Driven	PLL	N
1	0	Driven	Driven	Driven	Reference	Y
1	1	Driven	Driven	Driven	PLL	N

Notes: This output is driven and has an internal feedback for the PLL. The load on this output can be adjusted to change the skew between the reference and the Output.

#### Spread Spectrum Control and Input-Output Skew Table

Frequency (MHz) Device		Deviation (±%)	Input-Output Skew (±T <sub>SKEW</sub> )		
	PCS3P625Z05B / 09B	0.25	0.0625		
140	PCS3P625Z05C / 09C	0.5	0.125		

Note: T<sub>SKEW</sub> is measured in units of the Clock Period

#### Absolute Maximum Ratings

Symbol	Parameter	Rating	Unit
VDD	Supply Voltage to Ground Potential	-0.5 to +4.6	V
VIN	DC Input Voltage (CLKIN)	-0.5 to +7	v
T <sub>STG</sub>	Storage temperature	-65 to +125	°C
Ts	Max. Soldering Temperature (10 sec)	260	°C
TJ	Junction Temperature	150	°C
T <sub>DV</sub>	Static Discharge Voltage (As per JEDEC STD22- A114-B)	2	KV

# **Operating Conditions**

device reliability.

Parameter	Description	Min	Max	Unit
VDD	Supply Voltage	3.0	3.6	V
T <sub>A</sub>	Operating Temperature (Ambient Temperature)	-40	+85	°C
CL	Load Capacitance		10	pF
C <sub>IN</sub>	Input Capacitance		7	pF



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### **Electrical Characteristics**

Parameter	Description	Test Conditions	Min	Тур	Max	Unit
VIL	Input LOW Voltage <sup>5</sup>				0.8	V
VIH	Input HIGH Voltage⁵		2.0			V
IIL	Input LOW Current	V <sub>IN</sub> = 0V			50	μA
I <sub>IH</sub>	Input HIGH Current	V <sub>IN</sub> = VDD		4	100	μA
V <sub>OL</sub>	Output LOW Voltage <sup>6</sup>	I <sub>OL</sub> = 8mA			0.4	V
V <sub>OH</sub>	Output HIGH Voltage <sup>6</sup>	I <sub>OH</sub> = -8mA	2.4			v
I <sub>DD</sub>	Dynamic Supply Current	Unloaded outputs			65	mA
Zo	Output Impedance			23		Ω

Note: 5. CLKIN input has a threshold voltage of VDD/2 6. Parameter is guaranteed by design and characterization. Not 100% tested in production

### **Switching Characteristics**

Parameter	Test Conditions	Min	Тур	Мах	Unit
Input Frequency		100	- Typ	175	MHz
Output Frequency	10pF load	100		175	MHz
Duty Cycle $^{7,8}$ = (t <sub>2</sub> / t <sub>1</sub> ) * 100	Measured at VDD/2	40	50	60	%
Output Rise Time 7,8	Measured between 0.8V and 2.0V			2.5	nS
Output Fall Time <sup>7, 8</sup>	Measured between 2.0V and 0.8V			2.5	nS
Output-to-output skew 7,8	All outputs equally loaded			250	pS
Delay, CLKIN Rising Edge to CLKOUT Rising Edge <sup>8</sup>	Measured at VDD /2			±350	pS
Device-to-Device Skew 8	Measured at VDD/2 on the CLKOUT pins of the device			700	pS
Cycle-to-Cycle Jitter 7,8	Loaded outputs			±200	pS
PLL Lock Time <sup>8</sup>	Stable power supply, valid clock presented on CLKIN pin			1.0	mS

Note: 7. All parameters specified with 10pF loaded outputs. 8. Parameter is guaranteed by design and characterization. Not 100% tested in production



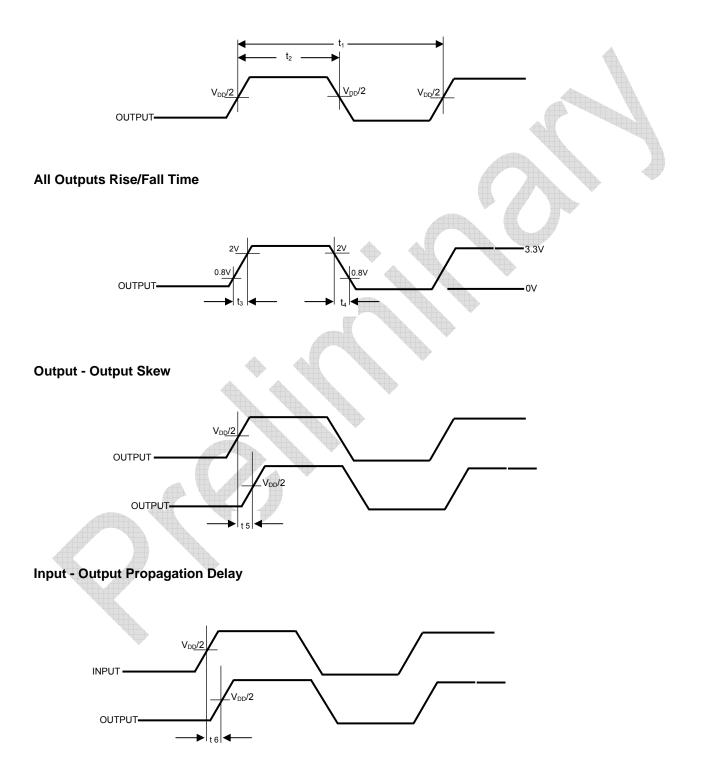
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**Switching Waveforms** 

**Duty Cycle Timing** 

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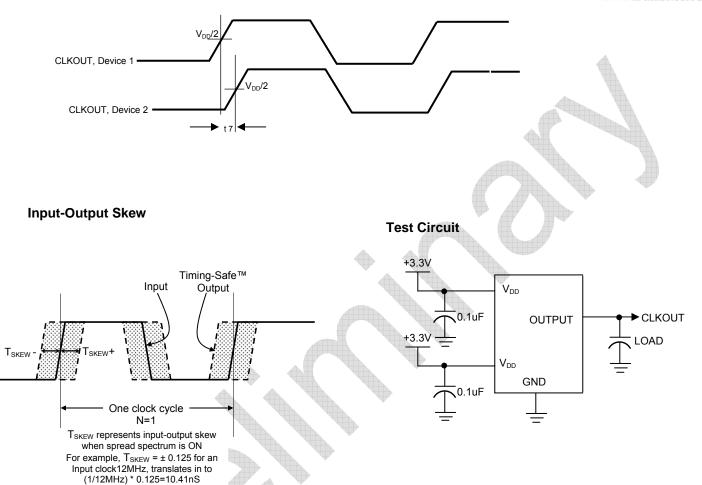


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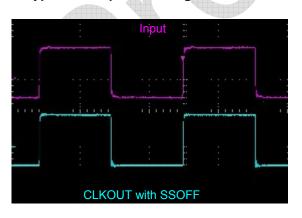
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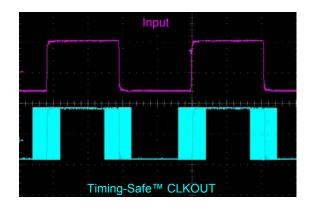
**Device - Device Skew** 





### A Typical example of Timing-Safe<sup>™</sup> waveform





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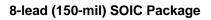


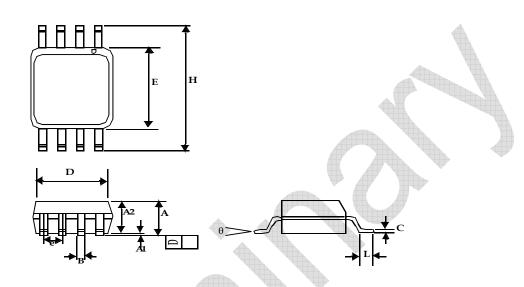
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**Package Information** 

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	Dimensions					
Symbol	Inc	hes	Millimeters			
	Min	Max	Min	Мах		
A1	0.004	0.010	0.10	0.25		
А	0.053	0.069	1.35	1.75		
A2	0.049	0.059	1.25	1.50		
В	0.012	0.020	0.31	0.51		
С	0.007	0.010	0.18	0.25		
D	0.193	BSC	4.90	BSC		
E	0.154	BSC	3.91	BSC		
e	0.050	BSC	1.27 BSC			
Н	0.236 BSC		0.236 BSC 6.00 E		BSC	
L	0.016	0.050	0.41	1.27		
θ	0°	8°	0°	8°		



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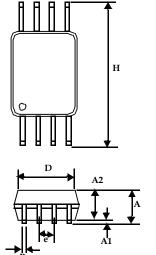
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8-lead TSSOP (4.40-MM Body)

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	Dimensions				
Symbol	Inc	hes	Millim	eters	
	Min	Мах	Min	Max	
А		0.043		1.10	
A1	0.002	0.006	0.05	0.15	
A2	0.033	0.037	0.85	0.95	
В	0.008	0.012	0.19	0.30	
c	0.004	0.008	0.09	0.20	
D	0.114	0.122	2.90	3.10	
E	0.169	0.177	4.30	4.50	
е	0.026	BSC	0.65	BSC	
Н	0.252 BSC		6.40	BSC	
L	0.020	0.028	0.50	0.70	
θ	0°	8°	0°	8°	







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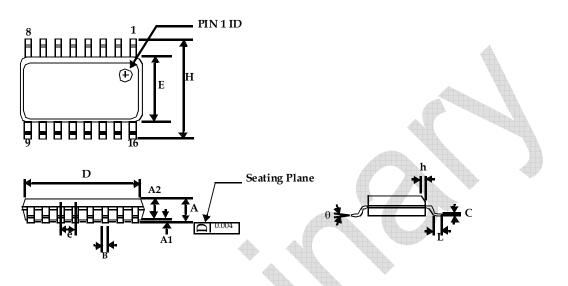
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# 16-lead (150 Mil) Molded SOIC Package

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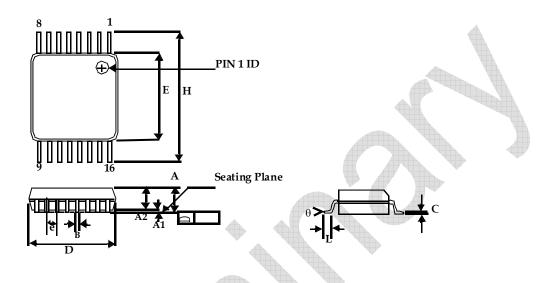


	Dimensions					
Symbol	Inc	hes	Millimeters			
	Min	Max	Min	Max		
А	0.053	0.069	1.35	1.75		
A1	0.004	0.010	0.10	0.25		
A2	0.049	0.059	1.25	1.50		
В	0.013	0.022	0.33	0.53		
C	0.008	0.012	0.19	0.27		
D	0.386	0.394	9.80	10.01		
E	0.150	0.157	3.80	4.00		
е	0.050	BSC	1.27	BSC		
н	0.228	0.244	5.80	6.20		
h	0.010	0.016	0.25	0.41		
L	0.016	0.035	0.40	0.89		
θ	0°	8°	0°	8°		

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			Dimen	sions	
	Symbol	Inch	ies	Millimeters	
		Min	Max	Min	Max
	А		0.043		1.20
	A1	0.002	0.006	0.05	0.15
	A2	0.031	0.041	0.80	1.05
	В	0.007	0.012	0.19	0.30
	С	0.004	0.008	0.09	0.20
	D	0.193	0.201	4.90	5.10
	Е	0.169	0.177	4.30	4.50
Á	e	0.026 BSC		0.65 BSC	
	Н	0.252	BSC	6.40	BSC
	L	0.020	0.030	0.50	0.75
	θ	0°	8°	0°	8°



16-lead TSSOP (4.40-MM Body)

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### **Ordering Code**

Ordering Code	Marking	Package Type	Temperature	
PCS3P625Z0xyG-08-ST	3P625Z0xyG	8-pin 150-mil SOIC-TUBE, Green	Commercial	
PCS3l625Z0xyG-08-ST	3l625Z0xyG	8-pin 150-mil SOIC-TUBE, Green	Industrial	
PCS3P625Z0xyG-08-SR	3P625Z0xyG	8-pin 150-mil SOIC-TAPE & REEL, Green	Commercial	
PCS3l625Z0xyG -08-SR	3l625Z0xyG	8-pin 150-mil SOIC-TAPE & REEL, Green	Industrial	
PCS3P625Z0xyG-08-TT	3P625Z0xyG	8-pin 4.4-mm TSSOP - TUBE, Green	Commercial	
PCS3l625Z00xyG -08-TT	3l625Z0xyG	8-pin 4.4-mm TSSOP - TUBE, Green	Industrial	
PCS3P625Z0xyG-08-TR	3P625Z0xyG	8-pin 4.4-mm TSSOP - TAPE & REEL, Green	Commercial	
PCS3l625Z0xyG -08-TR	3l625Z0xyG	8-pin 4.4-mm TSSOP - TAPE & REEL, Green	Industrial	
PCS3P625Z0xyG -16-ST	3P625Z0xyG	16-pin 150-mil SOIC-TUBE, Green	Commercial	
PCS3l625Z0xyG -16-ST	3l625Z0xyG	16-pin 150-mil SOIC-TUBE, Green	Industrial	
PCS3P625Z0xyG -16-SR	3P625Z0xyG	16-pin 150-mil SOIC-TAPE & REEL, Green	Commercial	
PCS3l625Z0xyG -16-SR	3l625Z0xyG	16-pin 150-mil SOIC-TAPE & REEL, Green	Industrial	
PCS3P625Z0xyG -16-TT	3P625Z0xyG	16-pin 4.4-mm TSSOP - TUBE, Green	Commercial	
PCS3l625Z0xyG -16-TT	3l625Z0xyG	16-pin 4.4-mm TSSOP - TUBE, Green	Industrial	
PCS3P625Z0xyG -16-TR	3P625Z0xyG	16-pin 4.4-mm TSSOP - TAPE & REEL, Green	Commercial	
PCS3I625Z0xyG -16-TR	31625Z0xyG	16-pin 4.4-mm TSSOP - TAPE & REEL, Green	Industrial	

Note: x=5 / 9; y=B / C

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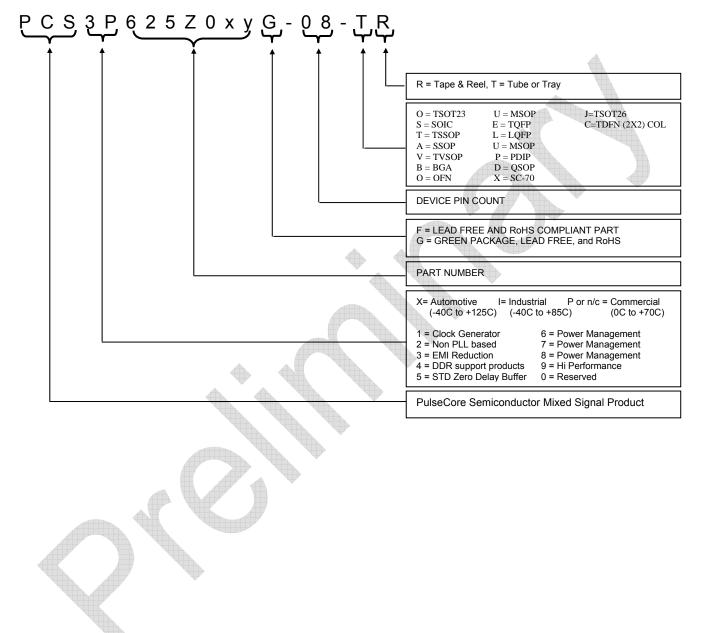


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#### **Device Ordering Information**

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Note: This product utilizes US Patent # 6,646,463 Impedance Emulator Patent issued to PulseCore Semiconductor, dated 11-11-2003 Many PulseCore Semiconductor products are protected by issued patents or by applications for patent

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